

41158

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of

Avner Pierre BADEHI

Serial No.: 09/725,166

Filed: November 29, 2000

For: METHODS FOR PRODUCING  
PACKAGED INTEGRATED CIRCUIT  
DEVICES AND PACKAGED  
INTEGRATED CIRCUIT DEVICES  
PRODUCED THEREBY

PATENT

Art Unit: 2811

Examiner: L. Thai

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#1/B  
3/12/02

SUPPLEMENTAL AMENDMENT

Commissioner for Patents  
Washington, D.C. 20231

Sir:

In further response to the outstanding Official Action dated 11 October 2001 and to place the application in better condition for allowance, please amend the above-identified application as follows:

In the Claims

Add the following new claims 38 - 40:

--38.

A crystalline substrate based device, comprising:

a crystalline substrate having formed thereon a microstructure; and

at least one packaging layer which is sealed over said microstructure and